Not for New Design

These parts are in production but have been determined to be NOT FOR NEW DESIGN. This classification indicates that sale of this device is currently restricted to existing customer applications. The device should not be purchased for new design applications because obsolescence in the near future is probable. Samples are no longer available.

Date of status change: Septemer 3, 2018

Recommended Substitutions:

For existing customer transition, and for new customers or new applications, use <u>APS12230</u>.

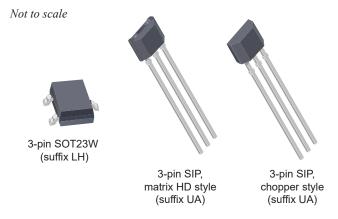
NOTE: For detailed information on purchasing options, contact your local Allegro field applications engineer or sales representative.

Allegro MicroSystems reserves the right to make, from time to time, revisions to the anticipated product life cycle plan for a product to accommodate changes in production capabilities, alternative product availabilities, or market demand. The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems assumes no responsibility for its use; nor for any infringements of patents or other rights of third parties which may result from its use.

FEATURES AND BENEFITS

- Symmetrical switchpoints
- Superior temperature stability
- Operation from unregulated supply
- Open-drain 25 mA output
- Reverse battery protection
- Activate with small, commercially available permanent magnets
- Solid-state reliability
- Small size
- Resistant to physical stress
- Enhanced ESD structures result in 8 kV HBM ESD performance without external protection components
- Internal protection circuits enable 40 V load dump compliance without external protection components

PACKAGES:



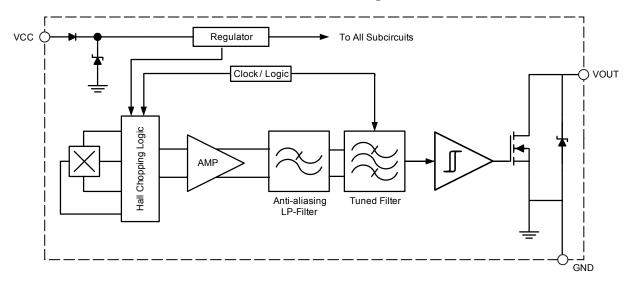
DESCRIPTION

These Hall-effect latches are extremely temperature-stable and stress resistant sensor ICs especially suited for operation over extended temperature ranges to 150°C. Superior high-temperature performance is made possible through a novel Schmitt trigger circuit that maintains operate and release point symmetry by compensating for temperature changes in the Hall element. Additionally, internal compensation provides magnetic switchpoints that become more sensitive with temperature, hence offsetting the usual degradation of the magnetic field with temperature. The symmetry capability makes these devices ideal for use in pulse-counting applications where duty cycle is an important parameter. The three basic devices (A1225, A1227, and A1229) are identical except for magnetic switchpoints.

Each device includes on a single silicon chip a voltage regulator, Hall-voltage generator, temperature compensation circuit, signal amplifier, Schmitt trigger, and a buffered open-drain output to sink up to 25 mA. The on-board regulator permits operation with supply voltages of 3.8 to 24 V.

The first character of the part number suffix determines the device operating temperature range. Suffix L is for -40° C to 150°C. Two package styles provide magnetically optimized packages for most applications. Suffix LH is a 3-pin SOT23W surface-mount package; suffix UA is a 3-pin ultramini SIP for through-hole mounting. The packages are lead (Pb) free with 100% matte-tin leadframe plating.

Functional Block Diagram



A1225, A1227 and A1229

Hall-Effect Latch for High Temperature Operation

SELECTION GUIDE

Part Number	Packing ^[1]	Package	Ambient Temperature, T _A	B _{RP} (min) (G)	B _{OP} (max) (G)
A1225LLHLT-T	7-in. reel, 3000 pieces/reel	3-pin SOT-23W surface mount			
A1225LLHLX-T	13-in. reel, 10000 pieces/reel	3-pin SOT-23W surface mount	–40°C to 150°C	-300	300
A1225LUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole			
A1227LLHLT-T	7-in. reel, 3000 pieces/reel	3-pin SOT-23W surface mount			
A1227LLHLX-T	13-in. reel, 10000 pieces/reel	3-pin SOT-23W surface mount	–40°C to 150°C	-175	175
A1227LUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole			
A1229LLHLT-T	7-in. reel, 3000 pieces/reel	3-pin SOT-23W surface mount			
A1229LLHLX-T	13-in. reel, 10000 pieces/reel	3-pin SOT-23W surface mount	–40°C to 150°C	-200	200
A1229LUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole			

 $^{^{[1]}}$ Contact Allegro $^{\scriptscriptstyle\mathsf{TM}}$ for additional packaging options.

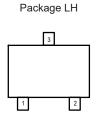


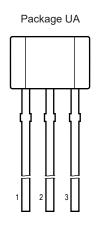


ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	Notes	Rating	Unit
Forward Supply Voltage	V _{CC}		30	V
Reverse Supply Voltage	V _{RCC}		-30	V
Output Off Voltage	V _{OUT}		30	V
Reverse Output Voltage	V _{ROUT}		-0.5	V
Continuous Output Current	I _{OUT(SINK)}		25	mA
Operating Ambient Temperature	T _A	Range L	-40 to 150	°C
Maximum Junction Temperature	T _J (max)		165	°C
Storage Temperature	T _{stg}		-65 to 170	°C

Pinout Diagrams





Terminal List Table

Number		Name	Function	
LH	UA	INAITIE	Function	
1	1	VCC	Input power supply	
2	3	VOUT	Output signal	
3	2	GND	Ground	



A1225, A1227 and A1229

Hall-Effect Latch for High Temperature Operation

ELECTRICAL CHARACTERISTICS: Valid at $T_A = -40$ °C to 150°C, $C_{BYPASS} = 0.1 \mu F$, $V_{CC} = 12 \text{ V}$, unless otherwise noted

Characteristics	Symbol	Test Conditions		Min.	Typ. [1]	Max.	Unit [2]
ELECTRICAL CHARACTERISTICS	•			*			
Supply Voltage	V _{CC}	Operating; T _J ≤ 165°C		3.8		24	V
Supply Current		B < B _{RP} (Output off)		_	_	6	mA
	Icc	B > B _{OP} (Output on)		_	_	6	mA
Supply Zener Voltage	V _{Z(sup)}	I _{CC} = 9	mA, T _A = 25°C	28	_	-	V
Reverse Battery Current	I _{Z(sup)}	V _{RCC} = -28 V, T _A = 25°C		_	_	- 5	mA
Power-On Time ^[3]	t _{PO}			_	_	12	μs
Power-On State	POS	B < B _{OP}		_	HIGH	-	_
Chopping Frequency	f _{chop}			_	400	-	kHz
OUTPUT STAGE CHARACTERISTIC	cs						
Output Saturation Voltage	V _{OUT(sat)}	I _{OUT} = 2	20 mA	_	175	400	mV
Output Leakage Current	I _{OFF}	V _{OUT} =	24 V, B < B _{RP}	_	< 1	10	μΑ
Output Rise Time [3][4]	t _r	R _L = 820 Ω, C _L = 20 pF		_	200	2000	ns
Output Fall Time [3][4]	t _f	R _L = 820 Ω, C _L = 20 pF		_	200	2000	ns
Output Zener Voltage	V _{Z(out)}	I _{OUT} = 3 mA, T _A = 25°C		30	_	_	V
MAGNETIC CHARACTERISTICS	,			,	•		
		A1225	T _A = 25°C	170	_	270	G
			Over operating temperature range	140	_	300	G
Operate Point	P	A1227	T _A = 25°C	50	_	150	G
Operate Point	B _{OP}		Over operating temperature range	50	_	175	G
		A1229	T _A = 25°C	100	_	180	G
		A1229	Over operating temperature range	80	_	200	G
		A1225	T _A = 25°C	-270	_	-170	G
			Over operating temperature range	-300	_	-140	G
Release Point	B _{RP}	A1227	T _A = 25°C	-150	_	– 50	G
	PRP		Over operating temperature range	-175	_	-50	G
		A1229	T _A = 25°C	-180	_	-100	G
			Over operating temperature range	-200	_	-80	G
		A1225	T _A = 25°C	340	_	540	G
			Over operating temperature range	280	_	600	G
Hysteresis (B _{OP} – B _{RP})	D D	A1227	T _A = 25°C	100		300	G
nysteresis (B _{OP} – B _{RP})	B _{HYS}		Over operating temperature range	100	_	350	G
		A1229	T _A = 25°C	200	_	360	G
			Over operating temperature range	160	_	400	G

 $^{^{[1]}}$ Typical data are at T_A = 25°C and V_{CC} = 12 V, and are for design estimations only. $^{[2]}$ 1 G (gauss) = 0.1 mT (millitesla).

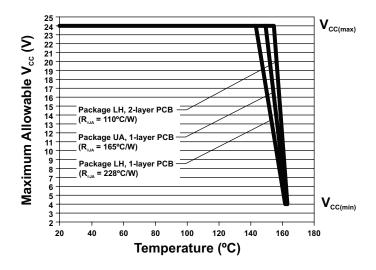


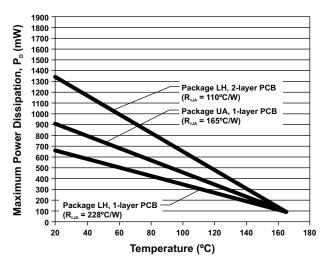
^[3] Minimum and maximum specifications verified by bench characterization and not guaranteed by Allegro final test.

 $^{^{[4]}}C_L$ = oscilloscope probe capacitance.

THERMAL CHARACTERISTICS: May require derating at maximum conditions; see application information

Characteristic	Symbol Notes		Rating	Unit
Package Thermal Resistance	$R_{ heta JA}$	Package LH, 2-layer PCB with 0.463 in. ² of copper area each side connected by thermal vias	110	°C/W
		Package LH, 1-layer PCB with copper limited to solder pads	228	°C/W
		Package UA, 1-layer PCB with copper limited to solder pads	165	°C/W

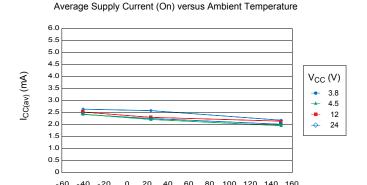




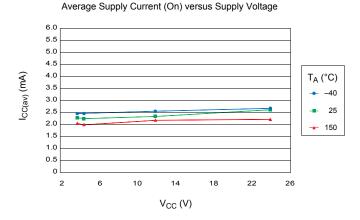


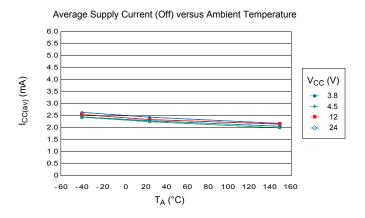
CHARACTERISTIC PERFORMANCE

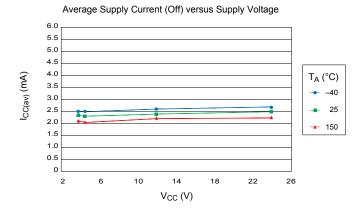
A1225, A1227, and A1229 Electrical Characteristics

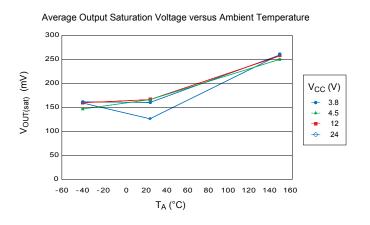


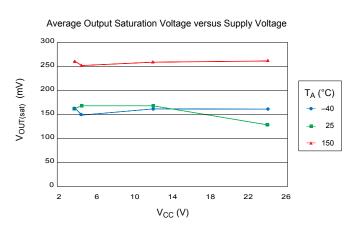
T_A (°C)



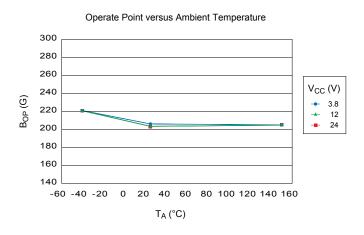


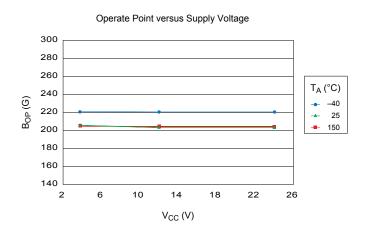


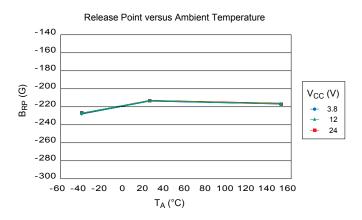


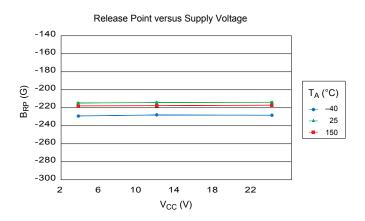


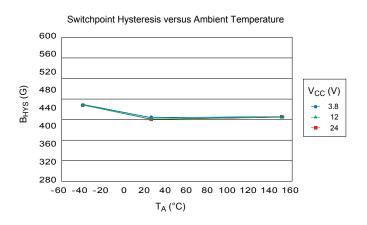
A1225 Magnetic Characteristics

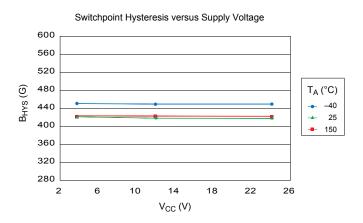




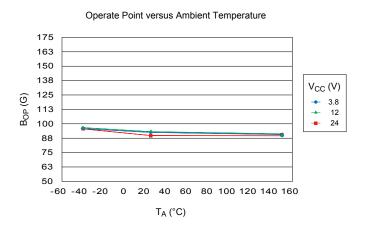


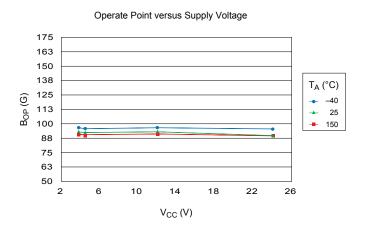


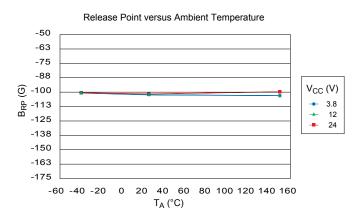


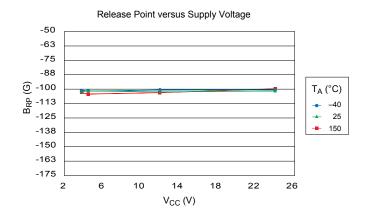


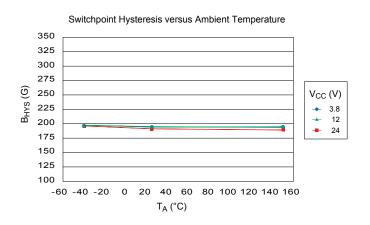
A1227 Magnetic Characteristics

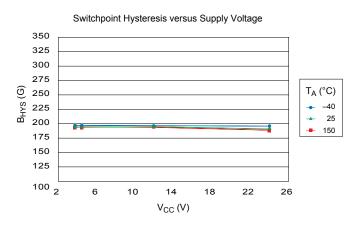




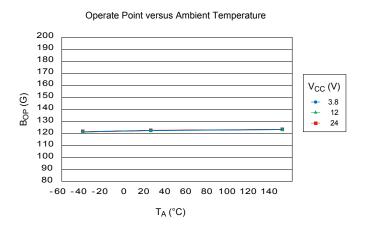


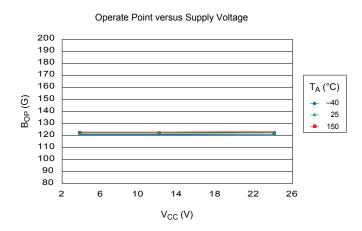


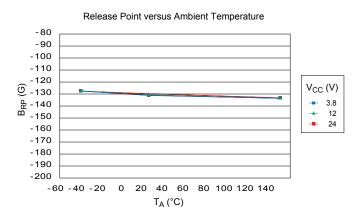


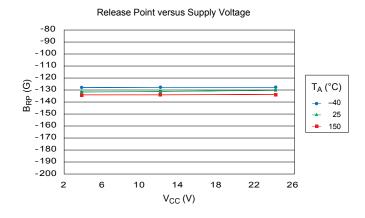


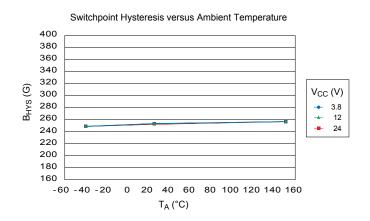
A1229 Magnetic Characteristics

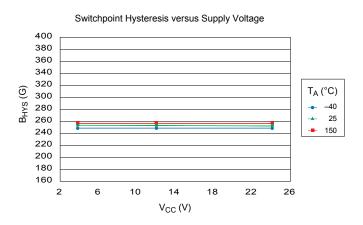












FUNCTIONAL DESCRIPTION AND APPLICATION INFORMATION

SWITCHING BEHAVIOR

The output of the A1225, A1227, and A1229 devices switches low (turns on) when a magnetic field perpendicular to the Hall element exceeds the operate point threshold, B_{OP} (see figure 1). After turn-on, the output is capable of sinking 25 mA and the output voltage is $V_{OUT(sat)}$. Notice that the device latches; that is, a south pole of sufficient strength towards the branded surface of the device turns the device on, and the device remains on with removal of the south pole.

When the magnetic field is reduced below the release point, B_{RP} , the device output goes high (turns off). The difference between the magnetic operate point and release point is the hysteresis, B_{HYS} , of the device. This built-in hysteresis allows clean switching of the output, even in the presence of external mechanical vibration and electrical noise.

When the device is powered-on in the hysteresis range, less than B_{OP} and higher than B_{RP} , the device output goes high. The correct output state is attained after the first excursion beyond B_{OP} or B_{RP} .

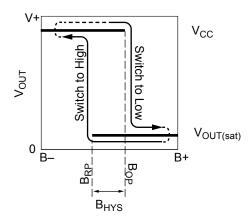


Figure 1. Output switching characteristics

APPLICATION INFORMATION

The simplest form of magnet that will operate these devices is a ring magnet, as shown in figure 2. Other methods of operation are possible.

In three-wire applications the device output is connected through a pull-up resistor to the supply pin or separate battery voltage (figure 3). Switching of the output signal indicates sufficient change of the magnetic field.

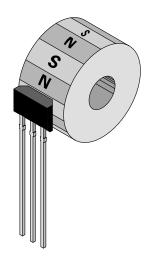


Figure 2. Typical magnetic target configuration using a ring magnet

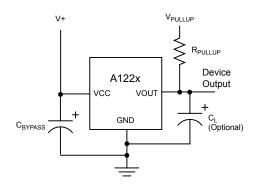


Figure 3. Typical 3-wire application circuit



A1225, A1227 and A1229

Hall-Effect Latch for High Temperature Operation

CHOPPER STABILIZATION TECHNIQUE

When using Hall-effect technology, a limiting factor for switchpoint accuracy is the small signal voltage developed across the Hall element. This voltage is disproportionally small relative to the offset that can be produced at the output of the Hall sensor IC. This makes it difficult to process the signal while maintaining an accurate, reliable output over the specified operating temperature and voltage ranges. Chopper stabilization is a unique approach used to minimize Hall offset on the chip. Allegro employs a technique to remove key sources of the output drift induced by thermal and mechanical stresses. This offset reduction technique is based on a signal modulation-demodulation process. The undesired offset signal is separated from the magnetic fieldinduced signal in the frequency domain, through modulation. The subsequent demodulation acts as a modulation process for the offset, causing the magnetic field-induced signal to recover its original spectrum at base band, while the DC offset becomes

a high-frequency signal. The magnetic-sourced signal then can pass through a low-pass filter, while the modulated DC offset is suppressed. In addition to the removal of the thermal and stress related offset, this novel technique also reduces the amount of thermal noise in the Hall sensor IC while completely removing the modulated residue resulting from the chopper operation. The chopper stabilization technique uses a high-frequency sampling clock. For the demodulation process, a sample-and-hold technique is used. This high-frequency operation allows a greater sampling rate, which results in higher accuracy and faster signalprocessing capability. This approach desensitizes the chip to the effects of thermal and mechanical stresses, and produces devices that have extremely stable quiescent Hall output voltages and precise recoverability after temperature cycling. This technique is made possible through the use of a BiCMOS process, which allows the use of low-offset, low-noise amplifiers in combination with high-density logic integration and sample-and-hold circuits.

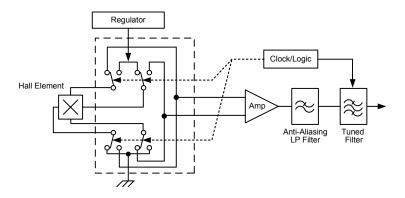


Figure 4. Chopper stabilization technique



Package LH 3-Pin SOT23W

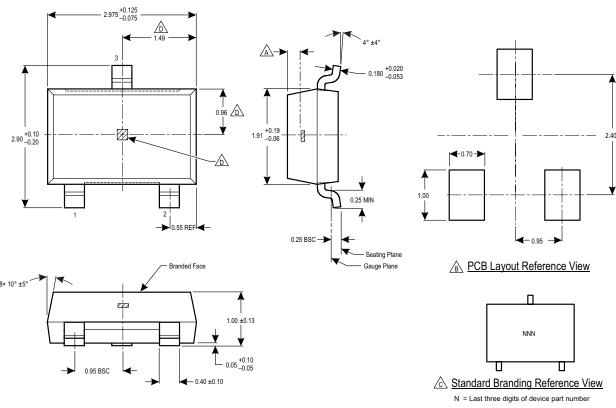
For Reference Only – Not for Tooling Use

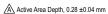
(Reference DWG-0000628)

Dimensions in millimeters – NOT TO SCALE

Dimensions exclusive of mold flash, gate burrs, and dambar protrusions

Exact case and lead configuration at supplier discretion within limits shown





Reference land pattern layout; all pads a minimum of 0.20 mm from all adjacent pads; adjust as necessary to meet application process requirements and PCB layout tolerances



A Branding scale and appearance at supplier discretion

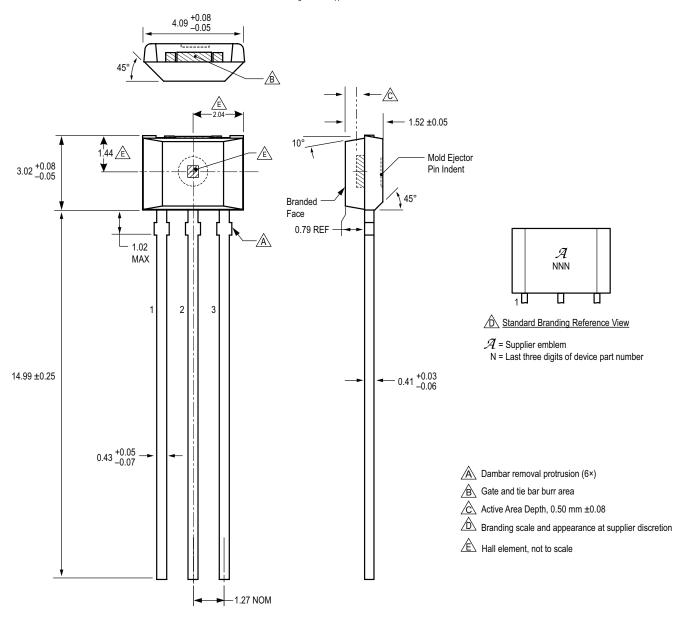
hall elements, not to scale

Package UA 3-Pin SIP, Matrix Style

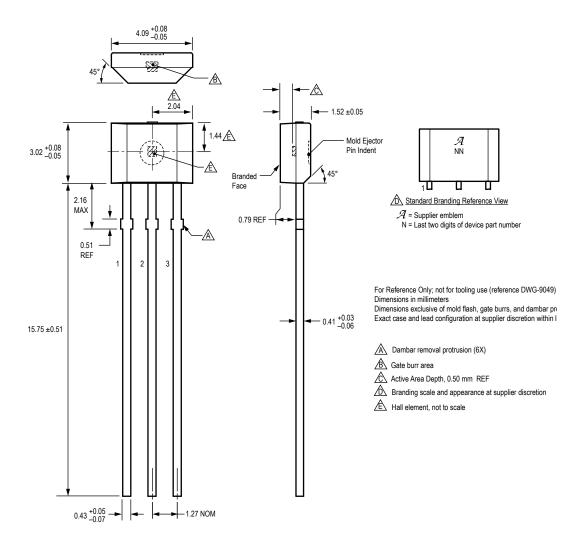
For Reference Only - Not for Tooling Use

(Reference DWG-0000404, Rev. 1) NOT TO SCALE Dimensions in millimeters

Dimensions in millimeters
Dimensions exclusive of mold flash, gate burrs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown



Package UA 3-Pin SIP, Chopper Style



A1225, A1227 and A1229

Hall-Effect Latch for High Temperature Operation

Revision History

Revision	Revision Date	Description of Revision
2	May 8, 2013	Update product offerings, editorial correction to I _{Z(sup)}
3	March 7, 2016	Updated product offerings
4	October 31, 2016	Chopper-style UA package designated as not for new design
5	June 19, 2018	Corrected matrix-style UA package drawing
6	September 10, 2018	Updated product status to not for new design
7	September 30, 2019	Updated LH package drawing (p. 11), and other minor editorial updates

Copyright 2019, Allegro MicroSystems.

Allegro MicroSystems reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Before placing an order, the user is cautioned to verify that the information being relied upon is current.

Allegro's products are not to be used in any devices or systems, including but not limited to life support devices or systems, in which a failure of Allegro's product can reasonably be expected to cause bodily harm.

The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems assumes no responsibility for its use; nor for any infringement of patents or other rights of third parties which may result from its use.

Copies of this document are considered uncontrolled documents.

For the latest version of this document, visit our website:

www.allegromicro.com

